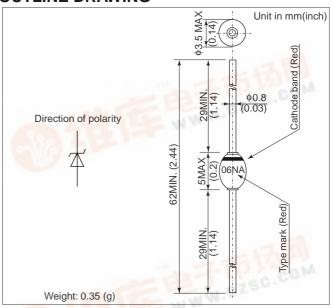
# **AW01**

#### **FEATURES**

- For stabilized power supply.
- Diffused-junction. Glass passivated and encapsulated.

#### **OUTLINE DRAWING**



### **ABSOLUTE MAXIMUM RATINGS**

Items	Symbols	Units	Ratings	
Permissible Power Dissipation	Р	W	1.0	
Operating Junction Temperature	OTISC	°C	-40 ~ <b>+</b> 150	
Storage Temperature	T <sub>stg</sub>	°C	-40 ~ <b>+</b> 150	
Maximum Permissible Current	I <sub>ZM</sub>	mA	Refer to characteristics column	
Non-Repetitive Peak Reverse One- Cycle Dissipation	P <sub>RSM</sub>	Wp	80	

Notes (1) Lead mounting: Lead temperature 300°C max. to 3.2mm from body for 5sec. max...

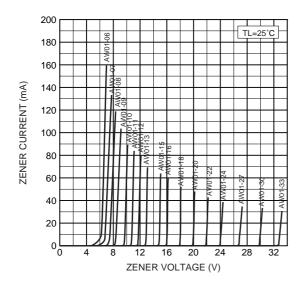
(2) Mechanical strength: Bending 90°×2 cycles or 180°×1 cycle, Tensile 2kg, Twist 90°×1 cycle.

CHARACTERISTICS(T, =25°C)

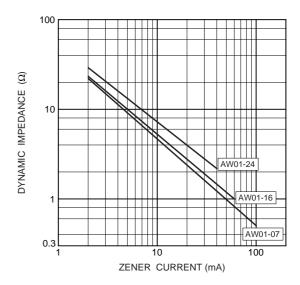
CHARACTERISTICS(T <sub>L</sub> =25 C)										
	100	Charac	Maximum	Typical						
Туре	Zener Voltage Vz (V)  Minimum Maximum		Maximum Dynamic Impedance Zz (ohm)	Test Current Iz (mA)	Permissible Current (TL=100°C) (L=10mm) I <sub>ZM</sub> (mA)	Zener Voltage Temperature Coefficient  Yz(%/°C)				
AW01-06	5.2	6.8	9	60	160	0.025				
AW01-07	6.2	7.9	7	25	135	0.035				
AW01-08	7.7	8.7	3	25	120	0.045				
AW01-09	8.5	9.6	3	25	105	0.053				
AW01-10	9.4	10.6	5	25	95	0.058				
AW01-11	10.4	11.6	5	25	85	0.063				
AW01-12	11.4	12.7	8	25	75	0.065				
AW01-13	12.4	14.1	8	25	70	0.068				
AW01-15	13.5	15.6	12	15	65	0.072				
AW01-16	15.3	17.1	12	15	60	0.074				
AW01-18	16.8	19.1	15	15	52	0.076				
AW01-20	18.8	21.2	15	15	48	0.078				
AW01-22	20.8	23.3	15	15	43	0.080				
AW01-24	22.7	25.6	15	10	40	0.081				
AW01-27	25.1	28.9	15	10	35	0.082				
# AW01-30	28.0	32.0	15	10	32	0.083				
pdf.dawo1933	31.0	35.0	15	10	30	0.084				

# **AW01**

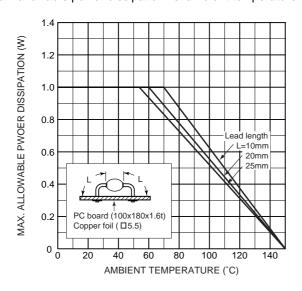
#### Typical zener characteristics



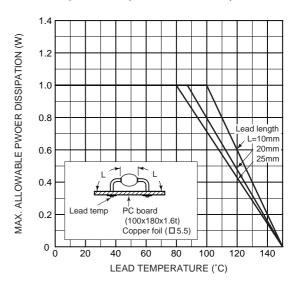
#### Typical dynamic impedance vs. zener current



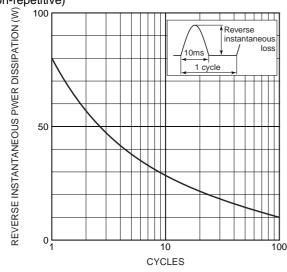
Max. allowable power dissipation vs. ambient temperature



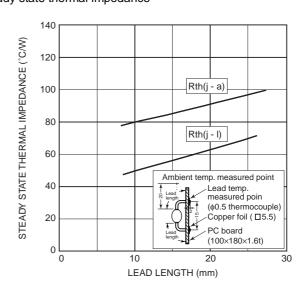
Max. allowable power dissipation vs. lead temperature



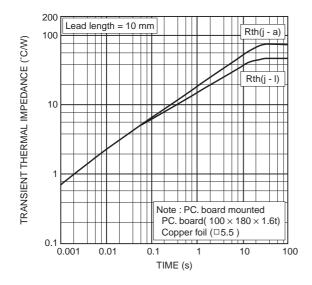
Reverse power characteristic (Non-repetitive)



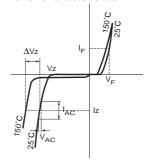
Steady state thermal impedance



#### Transient thermal impedance



#### Definition of zener characteristics



 $\begin{array}{lll} \Delta V_z : & \text{Zener voltage change} \\ V_z : & \text{Zener voltage (Test current } I_z) \\ I_z : & \text{Test current} \\ Z_z : & \text{Dynamic impedance=V}_{AC} \, / \, I_{AC} \\ \end{array}$ 

I<sub>F</sub>: Forward current
 V<sub>F</sub>: Forward voltage drop
 γz: Zener voltage average temperature coefficients

$$= \frac{\Delta Vz}{Vz} \times \frac{1}{(150-25)} \times 100$$

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